

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











20A, 45V - 200V Dual Common Cathode Schottky Rectifiers

FEATURES

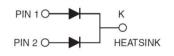
- Low power loss, high efficiency
- Ideal for automated placement
- Guardring for overvoltage protection
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition





Version: B15

TO-263AB (D²PAK)



MECHANICAL DATA

Case: TO-263AB (D²PAK)

Molding compound, UL flammability classification rating 94V-0

Moisture sensitivity level: level 1, per J-STD-020

Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test

Polarity: As marked

Weight: 1.37 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHAP	RACTERISTI	CS (T _A =2	5°C unless	s otherwise	e noted)		
		MBRS	MBRS	MBRS	MBRS	MBRS	
PARAMETER	SYMBOL	2045	2060	20100	20150	20200	Unit
		CT-Y	CT-Y	CT-Y	CT-Y	CT-Y	
Marking code		MBRS 2045CT	MBRS 2060CT	MBRS 20100CT	MBRS 20150CT	MBRS 20200CT	
Maximum repetitive peak reverse voltage	V_{RRM}	45	60	100	150	200	V
Maximum RMS voltage	V_{RMS}	31	42	70	105	140	V
Maximum DC blocking voltage	V _{DC}	45	60	100	150	200	V
Maximum average forward rectified current	I _{F(AV)}			20	•	•	Α
Peak repetitive forward current (Rated VR, Square wave, 20KHz)	I _{FRM}	20			Α		
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	150			Α		
Peak repetitive reverse surge current (Note 1)	I _{RRM}	1 0.5 A			Α		
Maximum instantaneous forward voltage (Note 2) $I_F=10A,T_J=25^{\circ}C$ $I_F=10A,T_J=125^{\circ}C$	V _F	0.70 0.60	0.80 0.70	0.85 0.75	0.99 0.87		V
Maximum reverse current @ rated VR T _J =25°C	I _R	0.1					m A
T _J =125°C		15	10		5		mA
Voltage rate of change (Rated V _R)	dV/dt	10000		V/µs			
Typical thermal resistance	$R_{ heta JC}$	1.5 2			°C/W		
Operating junction temperature range	TJ	- 55 to +150		°C			
Storage temperature range	T _{STG}	- 55 to +150			°C		

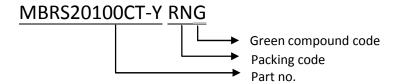
Note 1: tp = 2.0 µs, 1.0KHz

Note 2: Pulse test with PW=300 μ s, 1% duty cycle

Document Number: DS_D1408041

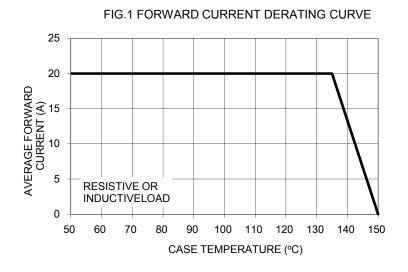


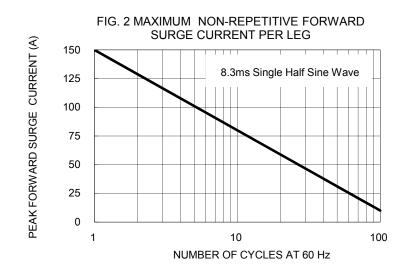
ORDER INFORMATION (EXAMPLE)

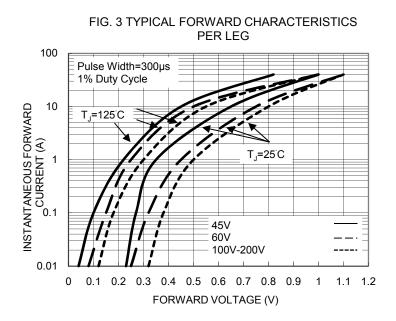


RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)







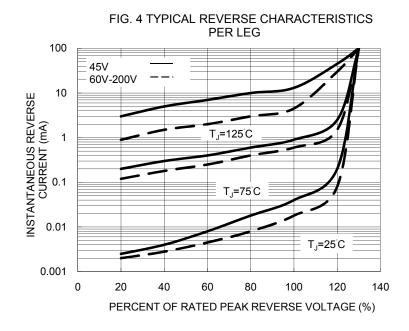






FIG. 5 TYPICAL JUNCTION CAPACITANCE PER LEG

10000

1000

45V
60V - 200V

0.1

1 10 100

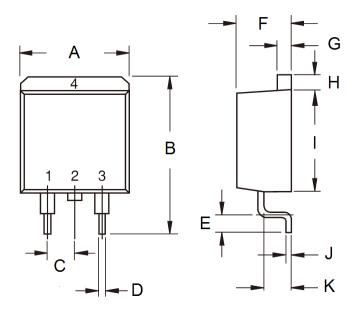
REVERSE VOLTAGE (V)

FIG. 6 TYPICAL TRANSIENT THERMAL IMPEDANCE PER LEG

100

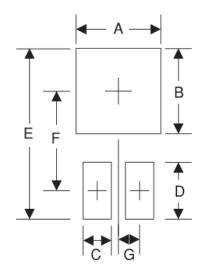
When the second of the second

PACKAGE OUTLINE DIMENSIONS TO-263AB (D²PAK)



DIM.	Unit (mm)		Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	-	10.5	-	0.413	
В	14.60	15.88	0.575	0.625	
С	2.41	2.67	0.095	0.105	
D	0.68	0.94	0.027	0.037	
Е	2.29	2.79	0.090	0.110	
F	4.44	4.70	0.175	0.185	
G	1.14	1.40	0.045	0.055	
Н	1.14	1.40	0.045	0.055	
I	8.25	9.25	0.325	0.364	
J	0.36	0.53	0.014	0.021	
K	2.03	2.79	0.080	0.110	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	10.8	0.425
В	8.3	0.327
С	1.1	0.043
D	3.5	0.138
E	16.9	0.665
F	9.5	0.374
G	2.5	0.098

MARKING DIAGRAM



P/N = Marking Code

G = Green Compound

YWW = Date Code

F = Factory Code



Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied,to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or seling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

Document Number: DS_D1408041 Version: B15